



KINESYS SOFTWARE, ELECTROGLAS AND INTERCON TECHNOLOGY FORM PARTNERSHIP TO AUTOMATE STRIP PROCESSING IN THE TEST ASSEMBLY AREA

MAJOR EQUIPMENT MANUFACTURERS COLLABORATE ON INTEGRATION OF ASSEMBLY LINE PRODUCTION SUPERVISOR (ALPS)

SEMICON West, San Jose, Calif., July 16, 2003 - KINESYS Software, Inc., a leading provider of software for the automation of semiconductor manufacturing processes, announced today that it has entered into separate agreements with two major equipment suppliers to collaborate on the development of non-proprietary solutions for the automation of semiconductor final manufacturing processes. The suppliers are Intercon Technology, Inc., a United States subsidiary of TOWA Corporation of Kyoto, Japan, and Electroglas, Inc. of San Jose.

KINESYS Software is the provider of the world's leading non-proprietary wafer mapping/equipment integration software for inkless assembly. The company's flagship Assembly Line Production Supervisor (ALPS) product line extends wafer mapping capability to strip and tray maps, and the equipment interface has

been extended to allow many different types of equipment to be connected, e.g. bump inspection, wafer probe, flip chip, mold, strip test, laser mark and singulation.

"Intercon Technology and Electroglas are important additions to a growing list of worldwide suppliers of assembly equipment that have integrated ALPS compatibility into their product line," said Dave Huntley, president, KINESYS Software. "The synergy of our combined expertise will enable us to integrate semiconductor assembly from wafer probe/sort through to the singulated device, providing process control solutions for a wide variety of equipment that will both reduce costs and afford manufacturers the data necessary to track flawed components through the assembly process right back to the wafer."

Intercon Technology will work with KINESYS Software on the integration of augmented mapping and tracking capability into their singulation equipment. Intercon Technology is the American subsidiary of TOWA Corporation responsible for the design and manufacture of singulation systems. TOWA Corporation is the world's largest supplier of auto-molding process technology and equipment.

"This arrangement between three companies, that have in common a long-standing history of developing successful automation solutions for assembly and test, emphasizes the growing importance of strip handling and testing," said Kim Tan, President, Intercon Technology. "Together KINESYS, Electroglas, and Intercon form a formidable team, united by a common goal of bringing process control solutions to the entire integrated packaging assembly line."

Electroglas, Inc. will likewise collaborate with KINESYS Software on the integration of strip testing into assembly. Electroglas recently announced its advanced prober based strip test handler – Sidewinder. Sidewinder's unique combination of high-speed handling and machine vision, based upon the company's proven prober technology, allows unprecedented accuracy and throughput in a strip test cell.

"Our goal at Electroglas is to provide fast, innovative answers to our customers' pressing manufacturing questions, and collaborating with experienced partners such as Intercon and KINESYS helps us accomplish this mission," said Bob Fenton, director of marketing, Electroglas, Inc. "Our combined products form a well integrated solution for strip processing that offers significant performance gains for customers, and we look forward to demonstrating that at SEMICON West."

ALPS will be demonstrated at SEMICON West 2003 (Final Manufacturing) in San Jose July 16-18 at both the Electroglas booth (# 10718) and the TOWA/Intercon booth (# 10142) in McEnery Hall at the San Jose Convention Center.

Companies interested in participating in beta testing the new ALPS features may contact KINESYS Software, Inc.

About KINESYS Software, Inc.

Founded in 1992, KINESYS Software is a privately held company based in Utrecht, The Netherlands and having a United States office in Petaluma, CA. The company is focused on the automation of semiconductor final manufacturing (test, assembly and packaging) processes. In particular, it offers innovative software products and expert support services for inkless assembly and equipment integration. For more information on the company, visit the web site, <http://www.kinesysinc.com>, or call Henk

Barreveld in the Netherlands at +31 (30) 233 2331, or Dave Huntley in the US office +1 (707) 766-8855.

About Intercon Technology, Inc.

Founded in 1986, Intercon Technology's core business is centered on delivering semiconductor capital equipment for singulation in final manufacturing of semiconductor devices. Intercon excels in identifying market opportunities then applying our technology to provide the market with industry leading products and services. Intercon holds patents in singulation and continues to differentiate technology by developing and integrating innovative solutions to new packaging challenges. More information about the company and its products is available at www.intercontechology.com.

About Electroglas, Inc.

Electroglas is a supplier of innovative probers, prober-based test handlers, test automation software and services that improve the overall effectiveness of semiconductor manufacturers' wafer and device testing processes by delivering faster answers to questions about device quality, manufacturing performance and corrective action needed. Headquartered in San Jose, California, the company has been a leading equipment provider to the semiconductor industry for over four decades, and has an installed base of more than 15,000 systems worldwide. Electroglas' stock trades on the NASDAQ National Market under the symbol "EGLS." More information about the company and its products is available at www.electroglas.com.

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